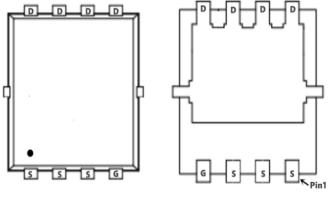
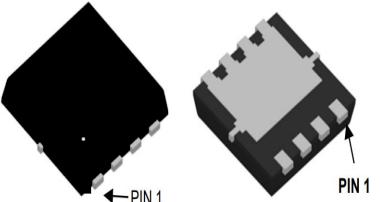
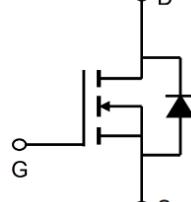


**TM50N06NF**
**N-Channel Enhancement Mosfet**

<b>General Description</b> <ul style="list-style-type: none"> <li>Low <math>R_{DS(ON)}</math></li> <li>RoHS and Halogen-Free Compliant</li> </ul> <b>Applications</b> <ul style="list-style-type: none"> <li>Load switch</li> <li>PWM</li> </ul>	<b>General Features</b> <p> <math>V_{DS} = 60V</math> <math>I_D = 50A</math>  <math>R_{DS(ON)} = 12\text{ m}\Omega(\text{typ.}) @ V_{GS} = 10V</math>          100% UIS Tested          100% <math>R_g</math> Tested       </p>
--	---



NF:DFN5x6-8L			
  			

Marking:50N06

<b>Absolute Maximum Ratings</b> ( $T_c=25^\circ C$ unless otherwise specified)			
Symbol	Parameter	Ratings	Units
$V_{DS}$	Drain-Source Voltage	60	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D$	Continuous Drain Current- $T_c=25^\circ C^{(2)}$	50	A
	Continuous Drain Current- $T_c=100^\circ C^{(2)}$	32	A
$E_{AS}$	Avalanche energy, single pulse <sup>(6)</sup>	98	mJ
$P_D$	Power Dissipation	62.5	W
$T_J, T_{STG}$	Operating and Storage Junction Temperature Range	-55 to +150	$^\circ C$

<b>Thermal Data</b>			
Symbol	Parameter	Max	Units
$R_{eJC}$	Thermal Resistance,Junction to Case	2	$^\circ C/W$
$R_{eJA}$	Thermal Resistance Junction to mbient	62	$^\circ C/W$

**TM50N06NF**
**N-Channel Enhancement Mosfet**

 Electrical Characteristics: ( $T_c=25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>Off Characteristics</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\ \mu\text{A}$	60	---	---	V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=60\text{V}, T_j=25^\circ\text{C}$	---	---	1	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Source Leakage Current	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{A}$	---	---	$\pm 100$	nA
<b>On Characteristics</b>						
$V_{\text{GS}(\text{th})}$	Drain-to-Source Leakage Current	$V_{\text{DS}} = V_{\text{GS}}, I_{\text{D}} = 250\mu\text{A}$	1.2	1.8	2.5	V
$R_{\text{DS}(\text{ON})}$	Drain-Source On Resistance	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=20\text{A}$	---	12	17	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}, I_{\text{D}}=20\text{A}$	---	16	21	
$R_{\text{G}}$	Gate Resistance	$f = 1.0\text{MHz}$ open drain	---	1.4	---	$\Omega$
<b>Dynamic Characteristics</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=30\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$	---	1880	---	pF
$C_{\text{oss}}$	Output Capacitance		---	110	---	
$C_{\text{rss}}$	Reverse Transfer Capacitance		---	88	---	
<b>Switching Characteristics</b>						
$t_{\text{d}(\text{on})}$	Turn-On Delay Time	$V_{\text{DS}}=30\text{V}, V_{\text{GS}}=10\text{V}, R_{\text{G}}=3\ \Omega, I_{\text{D}}=20\text{A}$	---	10	---	ns
$t_r$	Rise Time		---	23	---	ns
$t_{\text{d}(\text{off})}$	Turn-Off Delay Time		---	58	---	ns
$t_f$	Fall Time		---	8	---	ns
$Q_g$	Total Gate Charge	$V_{\text{GS}}=10\text{V}, V_{\text{DS}}=30\text{V}, I_{\text{D}}=20\text{A}$	---	37	---	nC
$Q_{\text{gs}}$	Gate-Source Charge		---	7.5	---	nC
$Q_{\text{gd}}$	Gate-Drain "Miller" Charge		---	8	---	nC
<b>Drain-Source Diode Characteristics</b>						
Symbol	Parameter	Conditions	Min	Typ	Max	Units
$V_{\text{SD}}$	Forward Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{S}}=20\text{A}, T_j=25^\circ\text{C}$	---	1.2	---	V
$I_s$	Continuous Diode Forward Current		---	---	50	A
$\text{trr}$	Continuous Source Current	$V_{\text{GS}} = 0\text{V}, I_{\text{F}}= 20\text{A}, dI/dt = 100\text{A}/\mu\text{s}$	---	29	---	ns
$\text{qrr}$	Pulsed Source Current		---	21	---	nC

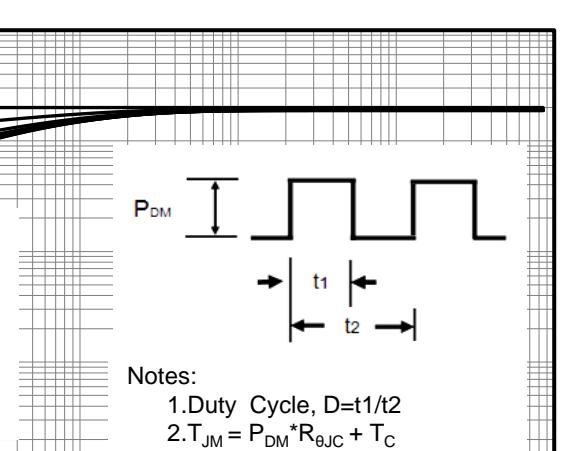
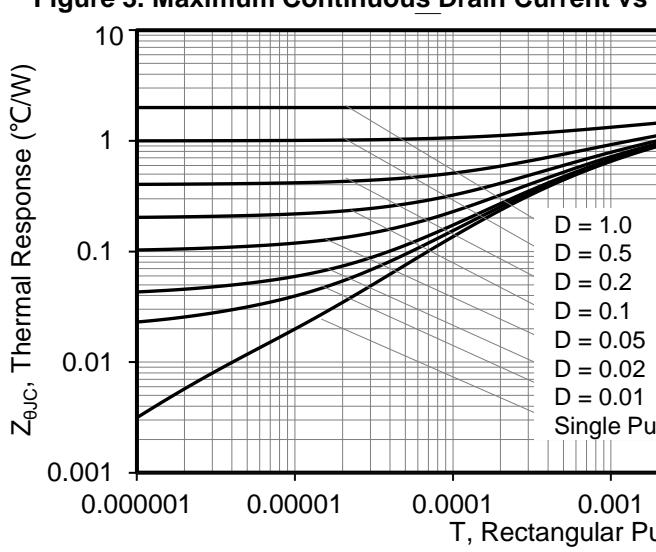
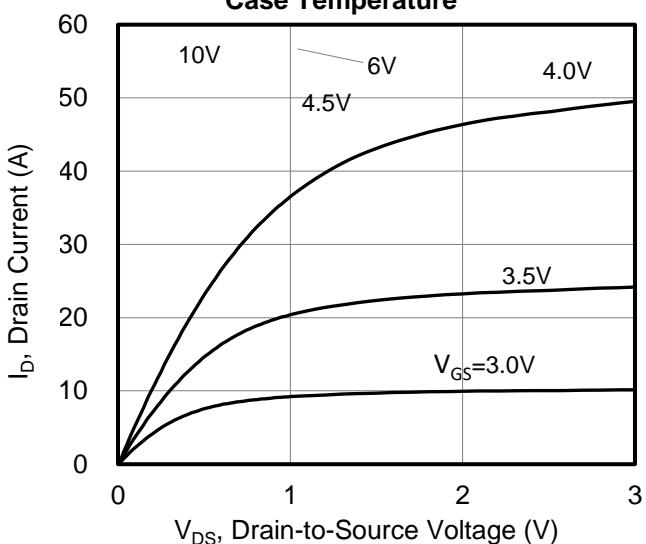
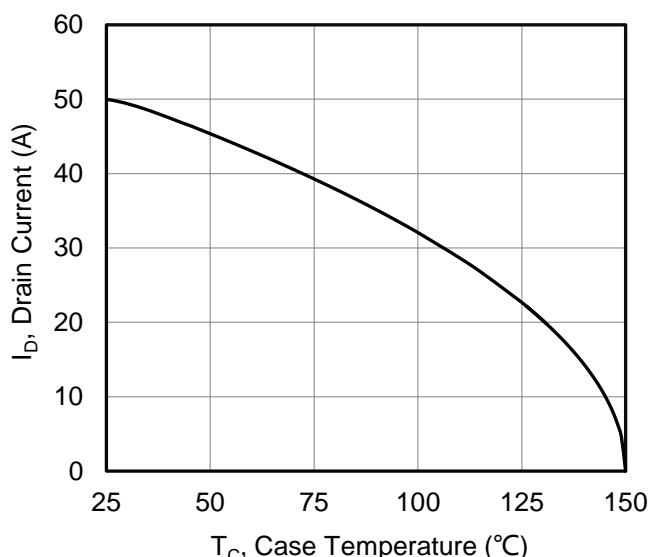
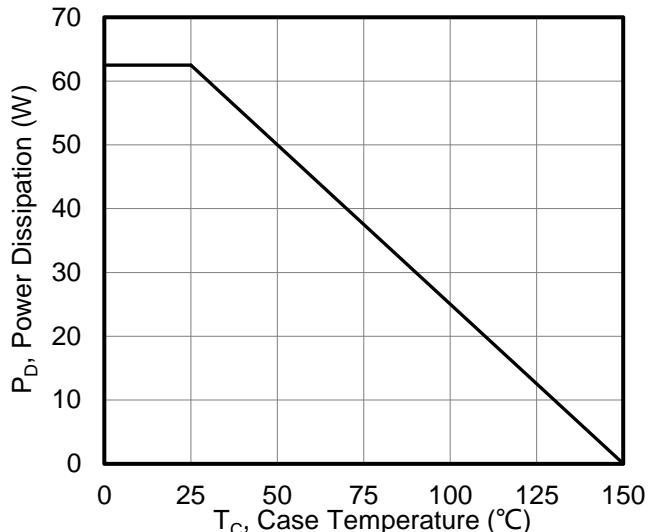
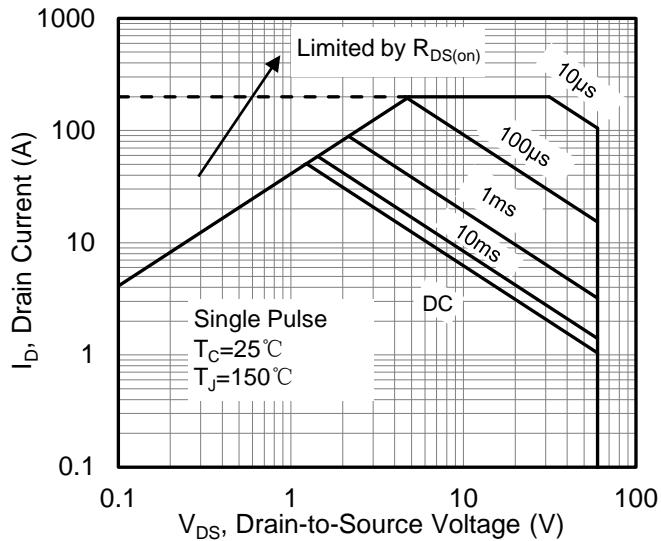
**Notes:**

- 1.L=0.5mH,  $V_{\text{DD}}=30\text{V}$ , Start  $T_j=25^\circ\text{C}$ .
- 2.Limited by maximum junction temperature.
- 3.Repetitive Rating: Pulse width limited by maximum junction temperature.

## TM50N06NF

## N-Channel Enhancement Mosfet

### Typical Characteristics





## TM50N06NF

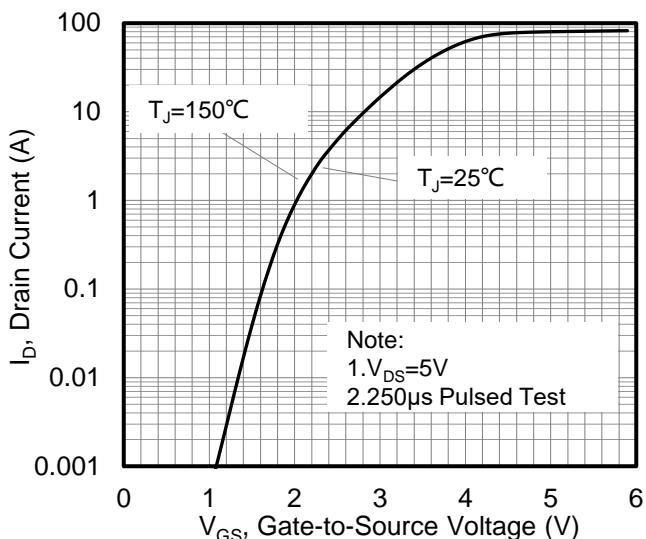


Figure 6. Typical Transfer Characteristics

## N-Channel Enhancement Mosfet

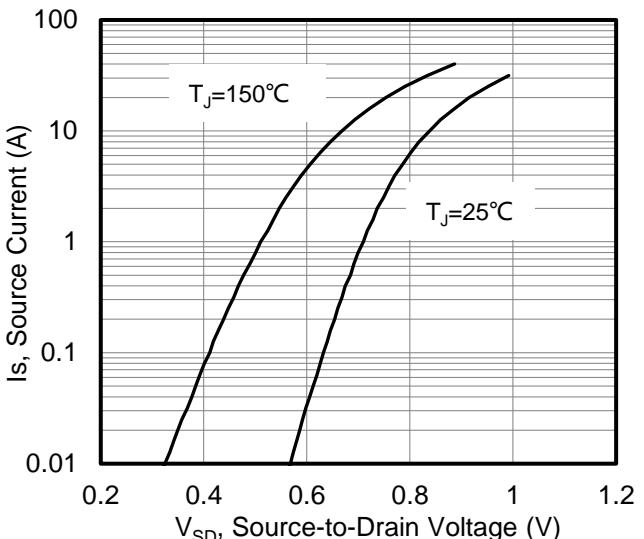


Figure 7. Typical Body Diode Transfer Characteristics

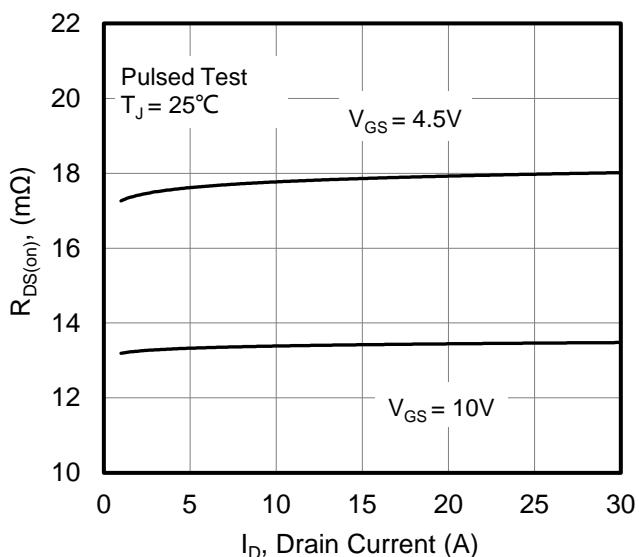


Figure 8. Drain-to-Source On Resistance vs Drain Current

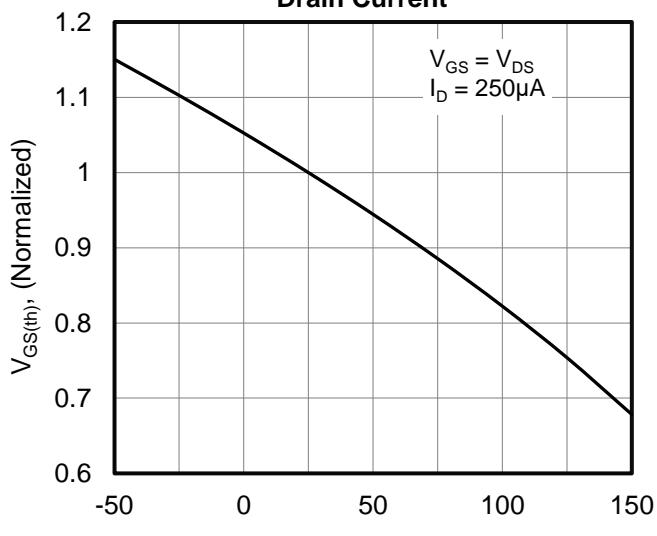
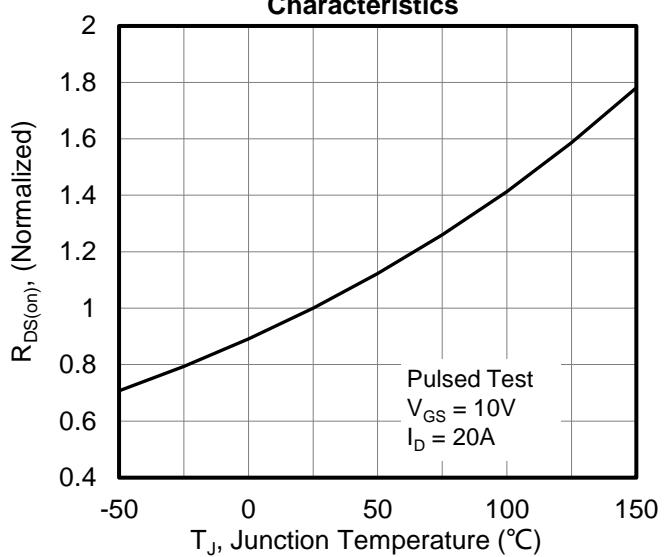
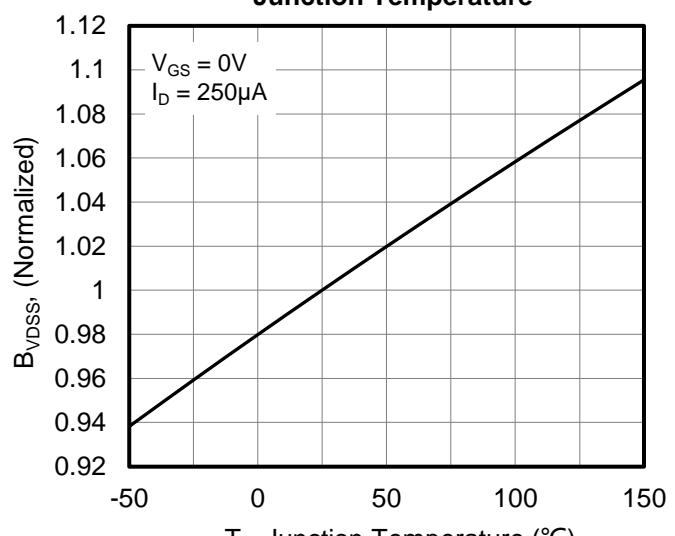
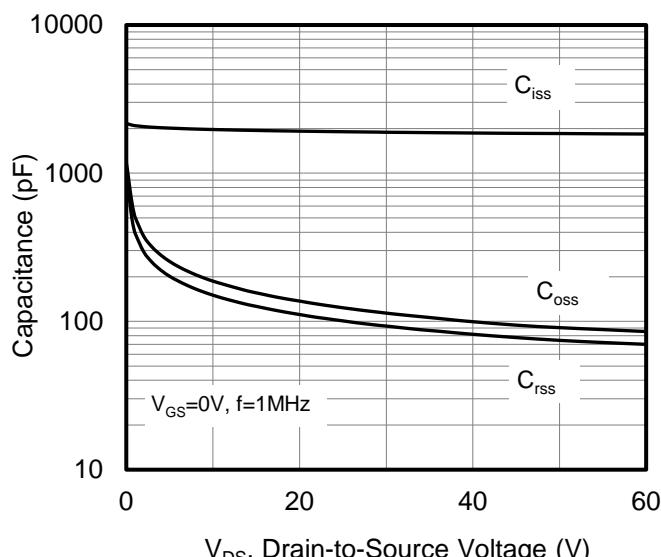


Figure 10. Normalized Threshold Voltage vs Junction Temperature

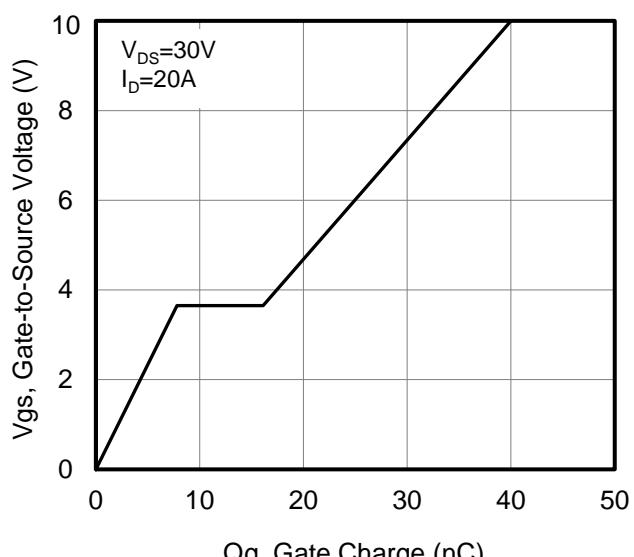


## TM50N06NF

## N-Channel Enhancement Mosfet

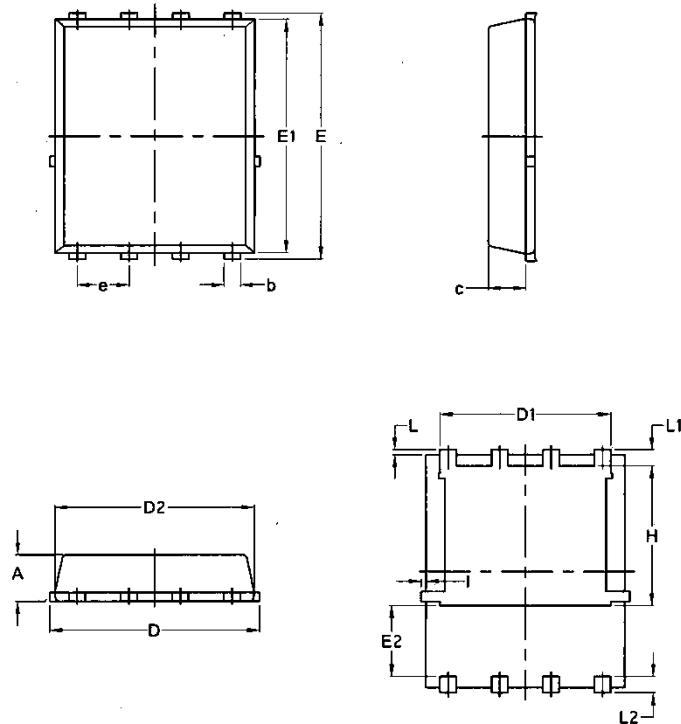


**Figure 12. Capacitance Characteristics**



**Figure 13. Typical Gate Charge vs Gate to Source Voltage**

## Package Mechanical Data:DFN5x6-8L



Symbol	Common			
	mm		Inch	
	Mim	Max	Min	Max
A	1.03	1.17	0.0406	0.0461
b	0.34	0.48	0.0134	0.0189
c	0.824	0.0970	0.0324	0.082
D	4.80	5.40	0.1890	0.2126
D1	4.11	4.31	0.1618	0.1697
D2	4.80	5.00	0.1890	0.1969
E	5.95	6.15	0.2343	0.2421
E1	5.65	5.85	0.2224	0.2303
E2	1.60	/	0.0630	/
e	1.27 BSC		0.05 BSC	
L	0.05	0.25	0.0020	0.0098
L1	0.38	0.50	0.0150	0.0197
L2	0.38	0.50	0.0150	0.0197
H	3.30	3.50	0.1299	0.1378
I	/	0.18	/	0.0070